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	Application No.	ication No. Applicant(s)	
Nation of Allowability	10/719,670	PARK ET AL.	Ţ
Notice of Allowability	Examiner	Art Unit	
	Tho v Duong	3743	
The MAILING DATE of this communication ap All claims being allowable, PROSECUTION ON THE MERITS I herewith (or previously mailed), a Notice of Allowance (PTOL-8 NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT of the Office or upon petition by the applicant. See 37 CFR 1.3	IS (OR REMAINS) CLOS 35) or other appropriate co RIGHTS. This application	SED in this application. If not includ ommunication will be mailed in due	ed course. THIS
1. \boxtimes This communication is responsive to <u>9/7/2004</u> .			
2. The allowed claim(s) is/are <u>1-20</u> .			
3. $igotimes$ The drawings filed on <u>20 November 2003</u> are accepted I	oy the Examiner.		
 4. Acknowledgment is made of a claim for foreign priority a) All b) Some* c) None of the: 1. Certified copies of the priority documents hat 2. Certified copies of the priority documents hat 3. Copies of the certified copies of the priority of International Bureau (PCT Rule 17.2(a)). * Certified copies not received: 	ave been received. ave been received in Appl	lication No	ition from the
Applicant has THREE MONTHS FROM THE "MAILING DATE noted below. Failure to timely comply will result in ABANDON THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.			quirements
5. A SUBSTITUTE OATH OR DECLARATION must be sub INFORMAL PATENT APPLICATION (PTO-152) which g			IOTICE OF
6. CORRECTED DRAWINGS (as "replacement sheets") m	nust be submitted.		
(a) ☐ including changes required by the Notice of Draftspe	erson's Patent Drawing R	Review (PTO-948) attached	
1) ☐ hereto or 2) ☐ to Paper No./Mail Date	·		
(b) ☐ including changes required by the attached Examine Paper No./Mail Date	er's Amendment / Comm	ent or in the Office action of	
Identifying indicia such as the application number (see 37 CFF each sheet. Replacement sheet(s) should be labeled as such it	l 1.84(c)) should be writter n the header according to	on the drawings in the front (not the 37 CFR 1.121(d).	back) of
 DEPOSIT OF and/or INFORMATION about the department of the department of			Note the
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Attachment(s) 1. ⊠ Notice of References Cited (PTO-892)	5. 🗌 Notice	of Informal Patent Application (PT	O-152)
2. Notice of Draftperson's Patent Drawing Review (PTO-948)		ew Summary (PTO-413),	•
 Information Disclosure Statements (PTO-1449 or PTO/SE Paper No./Mail Date <u>11/20/2003</u> 		r No./Mail Date ner's Amendment/Comment	
4. ☐ Examiner's Comment Regarding Requirement for Deposi	t 8. ⊠ Exami	ner's Statement of Reasons for Allo	owance
of Biological Material	9. 🗌 Other	Maann	m
		Tho v Duong Examiner Art Unit: 3743	• .

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DETAILED ACTION

Receipt of the English translation of the foreign priority document filed 10/19/2004 is acknowledged.

Election/Restrictions

Claims 3-6 and 15-16 have been withdrawn from further consideration pursuant to 37 CFR 1.142(b), as being drawn to a nonelected species, there being no allowable generic or linking claim. Applicant timely traversed the restriction (election) requirement in the reply filed on 9/7/2004.

Allowable Subject Matter

Since the generic independent claims 1 and 13 are allowed, the previous election requirement has been withdrawn. Claims 1-20 are now allowed.

The following is an examiner's statement of reasons for allowance: the prior art of record either in singular or in combination fail to disclose a stacked chip package comprising a board including at least one board pad and at least one dumpy board pad; a plurality of chips, each having at least one bonding pad, the plurality of chips being stacked one atop the other on the board; and at least one heat transfer wire disposed between the chips, wherein at least one end of each of heat transfer wire is connected to at least one dumpy board pad, and at least one bonding pad is electrically connected to at least one of the board pad. References to Hoffman et al. (US 6,737,750) and Chen et al. (US 6,716,676) are the closest prior arts. However, these references do not disclose a heat transfer wire disposed between the chips and connected to a dummy board pad located on the same board with the board pad. The thermal conductive means, which are

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disposed between the chips as shown by the prior art of records, are thermal conductive tape, adhesive or a support plate structure.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Hoffman et al. (US 6,737,750) discloses a structures for improving heat dissipation in stacked semiconductor package.

Johnson (US 4,763,188) discloses a packaging system for multiple semiconductor devices.

Den (US 6,720,662) discloses a semiconductor device having stacked of chips with plates disposed between.

Papageorge et al. (US 5,438,224) discloses an integrated circuit package having a face to face IC chip arrangement.

Chen et al. (6,716,676) discloses a thermally-enhanced stacked chips.

Tuckerman et al. (US 5,804,004) discloses a stacked device for multichip modules.

Schneider et al. (US 5,610,442) discloses semiconductor device package having a heat transfer means disposed on top of the chip.

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Yang (US 6,291,881) discloses a dual silicon chip package.

Hsuan et al. (US 6,236,109) discloses a stacked chip having a heat sink on top of the chip.

Ball (US 6,784,023) discloses a stacked chip having a heat sink disposed there between.

Any inquiry concerning this communication or earlier communication from the examiner should be directed to Tho Duong whose telephone number is (703) 305-0768. The examiner can normally be reached on from 9:30-6 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Henry Bennet, can be reached on (703) 308-0101. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0861.

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October 28, 2004

Tho Duong

Manono

Patent Examiner.